



Dual N-Channel 30-V (D-S) MOSFET with Schottky Diode

CHARACTERISTICS

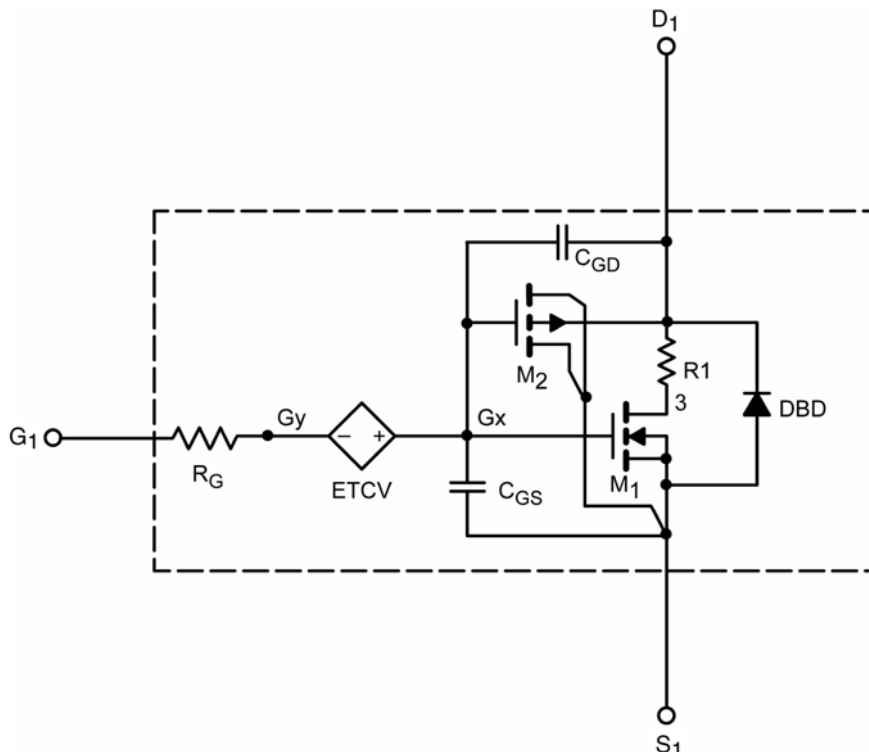
- N-Channel Vertical DMOS
- Macro Model (Subcircuit Model)
- Level 3 MOS
- Apply for both Linear and Switching Application
- Accurate over the - 55 °C to 125 °C Temperature Range
- Model the Gate Charge, Transient, and Diode Reverse Recovery Characteristics

DESCRIPTION

The attached spice model describes the typical electrical characteristics of the N-channel vertical DMOS. The subcircuit model is extracted and optimized over the - 55 °C to 125 °C temperature ranges under the pulsed 0 V to 10 V gate drive. The saturated output impedance is best fit at the gate bias near the threshold voltage.

A novel gate-to-drain feedback capacitance network is used to model the gate charge characteristics while avoiding convergence difficulties of the switched C_{gd} model. All model parameter values are optimized to provide a best fit to the measured electrical data and are not intended as an exact physical interpretation of the device.

SUBCIRCUIT MODEL SCHEMATIC



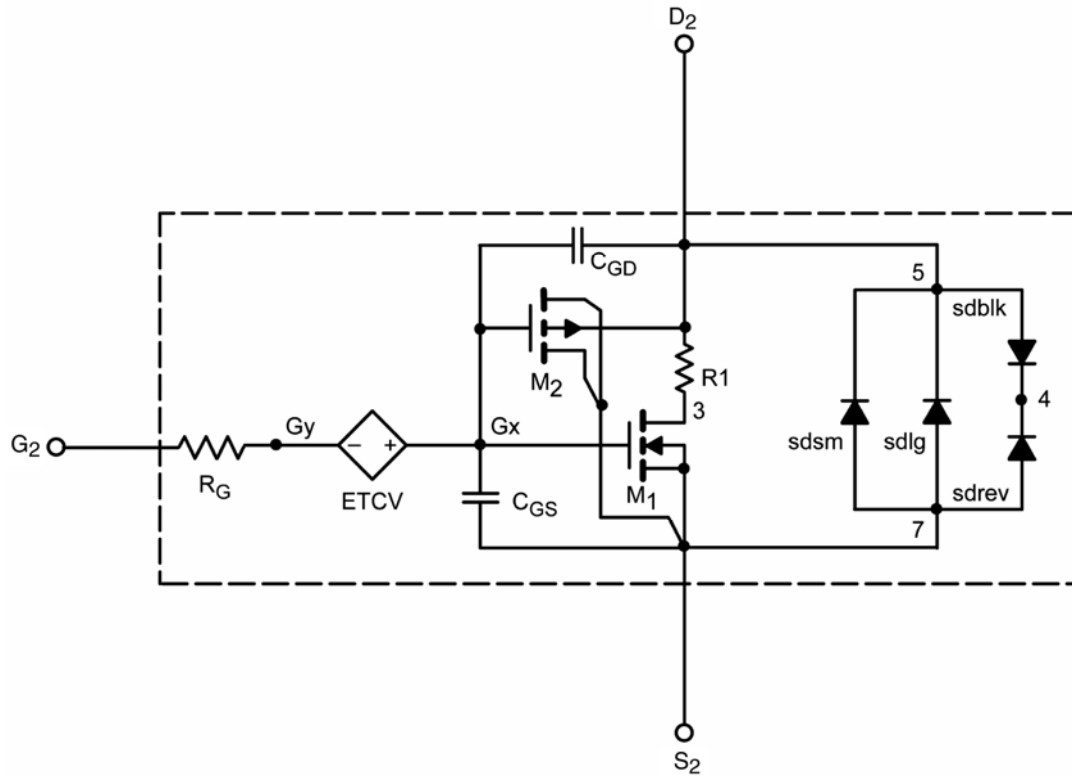
This document is intended as a SPICE modeling guideline and does not constitute a commercial product data sheet. Designers should refer to the appropriate data sheet of the same number for guaranteed specification limits.

SPICE Device Model Si4830CDY



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SUBCIRCUIT MODEL SCHEMATIC





SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$ UNLESS OTHERWISE NOTED)

| Parameter | Symbol | Test Condition | Simulated Data | Measured Data | Unit |
|---|--------------|--|----------------|---------------|----------|
| Static | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$ | Ch-1 | 1.8 | V |
| | | | Ch-2 | 1.8 | |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | $V_{GS} = 10\text{ V}, I_D = 8\text{ A}$ | Ch-1 | 0.0154 | Ω |
| | | | Ch-2 | 0.0154 | |
| | | | Ch-1 | 0.020 | |
| | | | Ch-2 | 0.020 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 15\text{ V}, I_D = 8\text{ A}$ | Ch-1 | 29 | S |
| | | | Ch-2 | 29 | |
| Diode Forward Voltage ^a | V_{SD} | $I_S = 1\text{ A}$ | Ch-1 | 0.74 | V |
| | | | Ch-2 | 0.46 | |
| Dynamic^b | | | | | |
| Input Capacitance | C_{iss} | Channel 1 $V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ Channel 2 $V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$ | Ch-1 | 945 | pF |
| | | | Ch-2 | 945 | |
| Input Capacitance | C_{oss} | | Ch-1 | 184 | |
| | | | Ch-2 | 184 | |
| Reverse Transfer Capacitance | C_{rss} | | Ch-1 | 64 | |
| | | | Ch-2 | 64 | |
| Total Gate Charge | Q_g | $V_{DS} = 15\text{ V}, V_{GS} = 10\text{ V}, I_D = 8\text{ A}$ | Ch-1 | 14 | nC |
| | | | Ch-2 | 14 | |
| | | Channel-1 $V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$ | Ch-1 | 7 | |
| | | | Ch-2 | 7 | |
| Gate-Source Charge | Q_{gs} | Channel-2 $V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 8\text{ A}$ | Ch-1 | 2.7 | |
| | | | Ch-2 | 2.7 | |
| Gate-Drain Charge | Q_{gd} | | Ch-1 | 2.1 | |
| | | | Ch-2 | 2.1 | |

Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

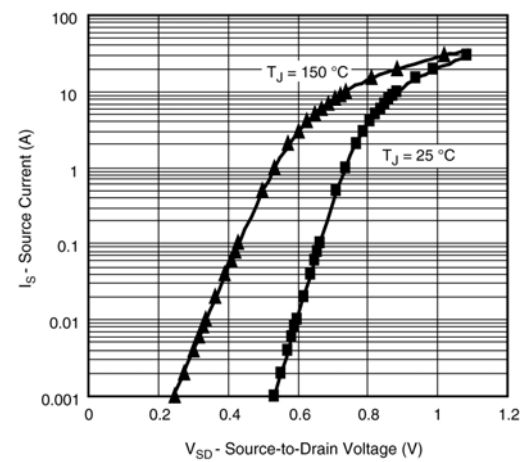
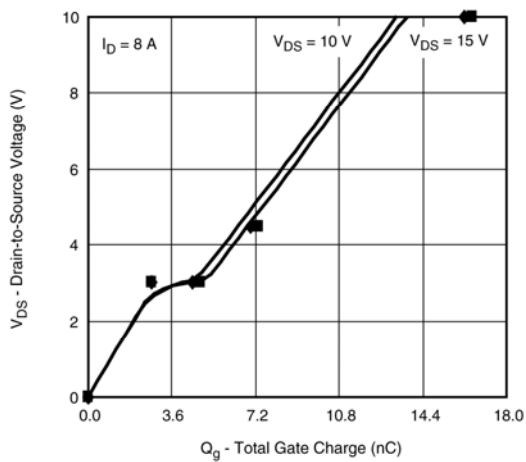
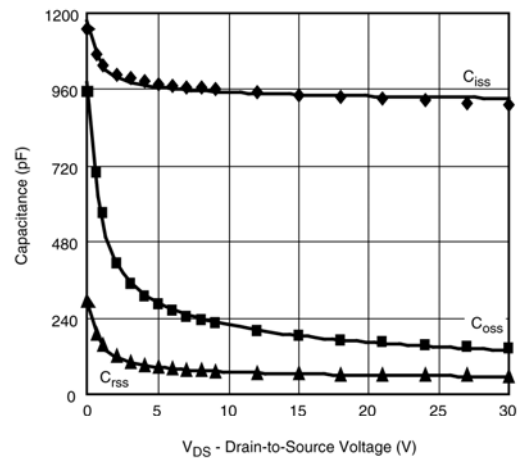
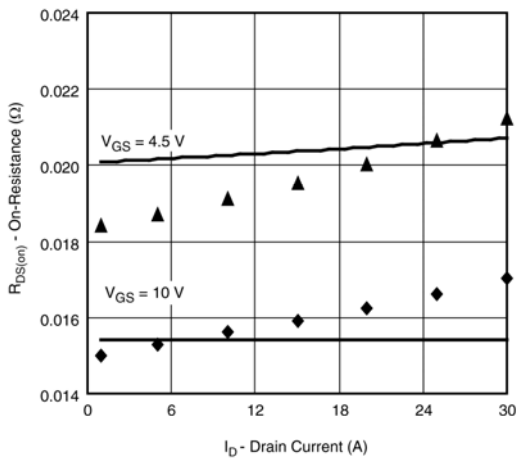
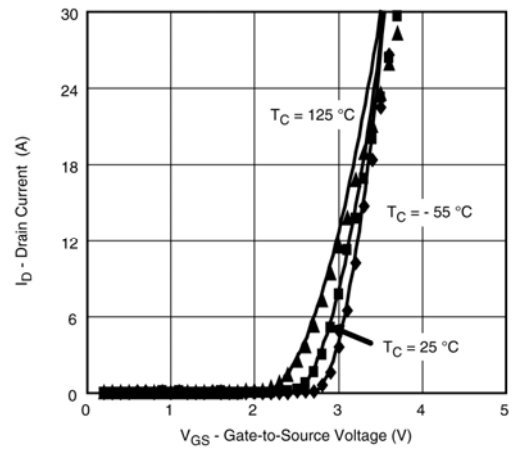
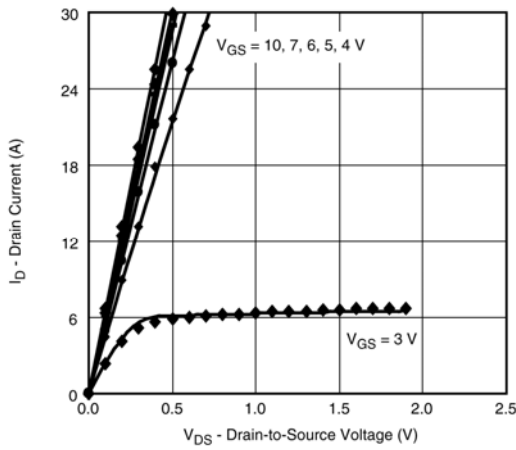
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SPICE Device Model Si4830CDY

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CHANNEL 1 - COMPARISON OF MODEL WITH MEASURED DATA ($T_J = 25\text{ }^\circ\text{C}$ UNLESS OTHERWISE NOTED)



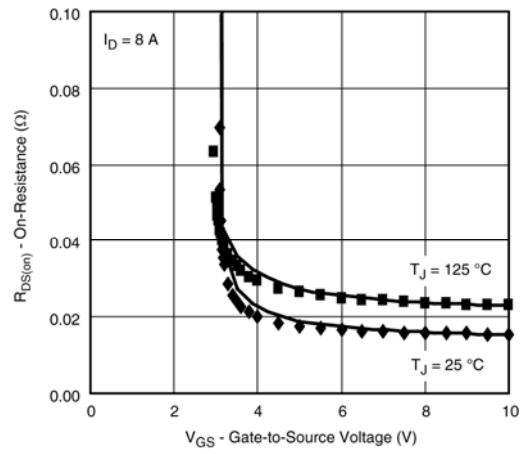
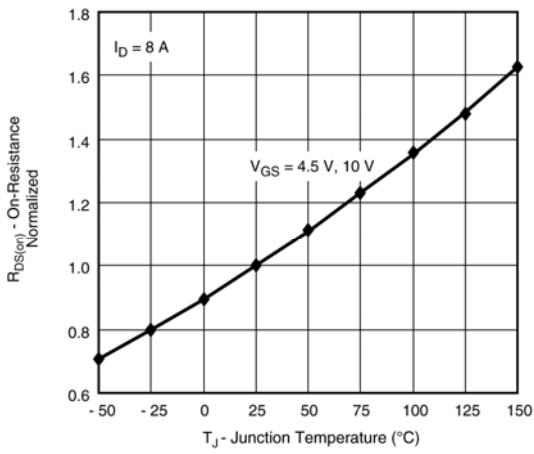
Note: Dots and squares represent measured data.



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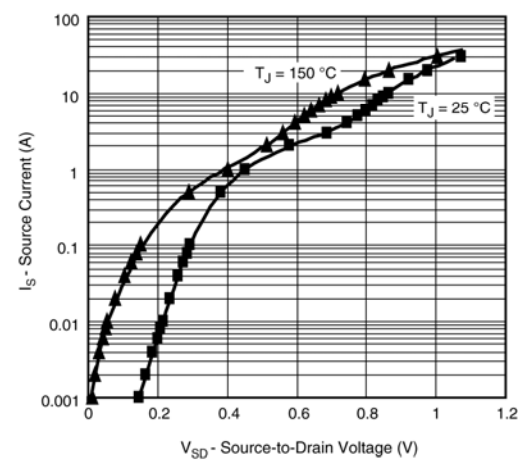
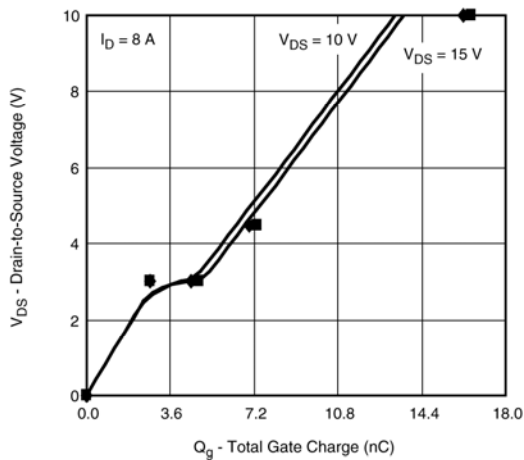
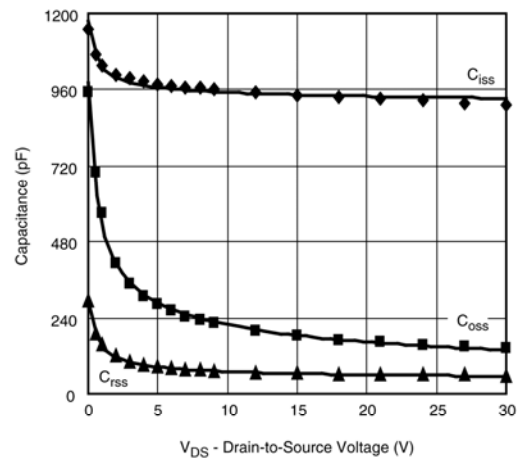
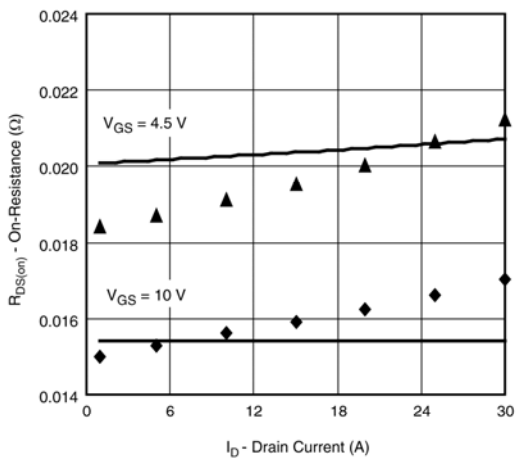
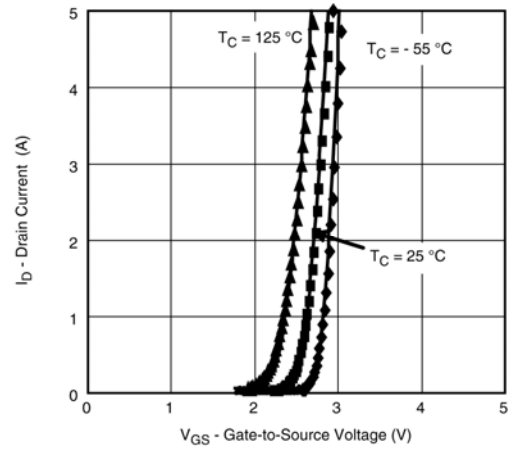
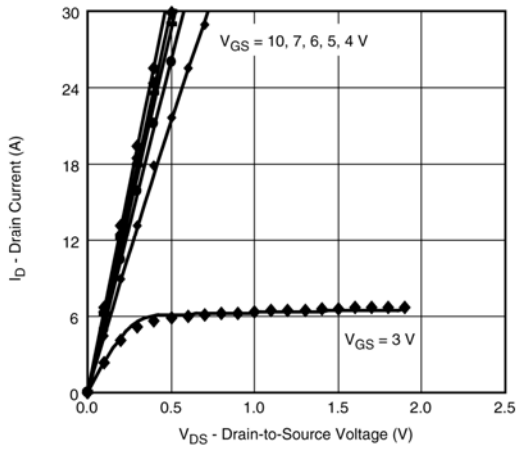
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CHANNEL 2 - COMPARISON OF MODEL WITH MEASURED DATA ($T_J = 25\text{ }^\circ\text{C}$ UNLESS OTHERWISE NOTED)



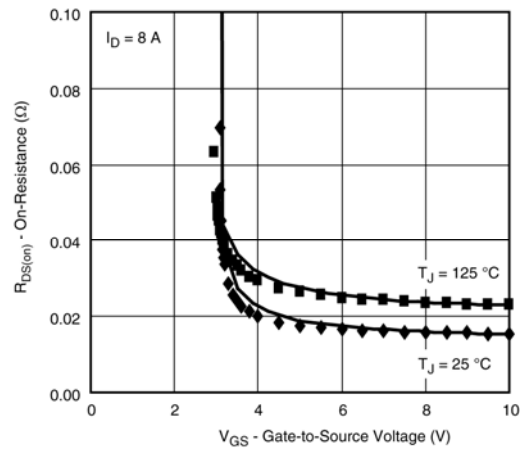
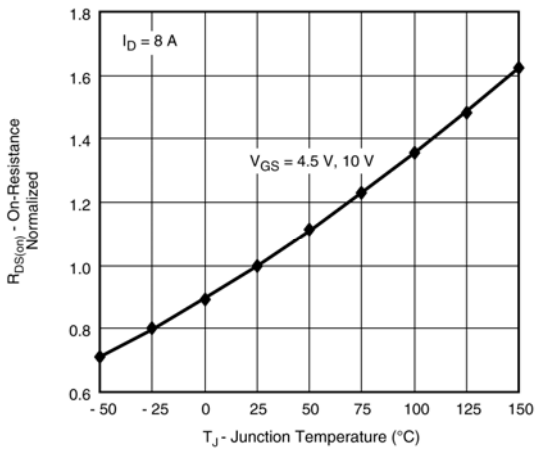
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CHANNEL 2 - COMPARISON OF MODEL WITH MEASURED DATA ($T_J = 25\text{ }^\circ\text{C}$ UNLESS OTHERWISE NOTED)



Note: Dots and squares represent measured data.



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